

Product Qualification Report

BSP125

Small Signal MosFETs

Description

This product qualification report describes the characteristics of the product with respect to quality and reliability.

The qualification sample selection was done on production lots which were manufactured and tested on standard production processes and meet the defined requirements.

The qualification test results of those products as outlined in this document are based on **AEC** for target applications and may reference existing qualification results of similar products. Such referencing is justified by the structural similarity of the products.

Qualification Assessment

Qualified according to **AEC Q101** and assessed as PASS

For further information about comparable products, please contact the nearest Infineon Technologies office (www.infineon.com).

qualified since May 2013

BSP125
PG-SOT223-4
MSL: 1, 260°C

Electrical Stress Test Results:

| Test Description | Abbr. | Condition | Duration | Lots/SS | Fail/Qty | Result |
|---|---------|--|------------|---------|----------|--------|
| High Temperature Reverse Bias JESD22 A108 | HTRB | Ta = 150°C/175°C ** V _{DS} = V _{DS,max} | 1000 h | 3 x 77 | 0 / 231 | PASS |
| High Temperature Gate Bias JESD22 A108 | HTGB | Ta = 150°C/175°C ** V _{GS} ≥ ±80% V _{GS,max} | 1000 h | 3 x 77 | 0 / 231 | PASS |
| High Humidity High Temperature Reverse Bias JESD22 A101 | H3TRB* | Ta = 85°C RH = 85% V _{DS} = 80% V _{DS,max} | 1000 h | 3 x 77 | 0 / 231 | PASS |
| Intermittent Operational Life Test MIL-STD 750 / Meth.1037 | IOL* | Delta T = 100K | 15000 cyc. | 3 x 77 | 0 / 231 | PASS |
| ESD (HBM) JESD22-A114 | HBM**** | 1A (250 V to < 500 V) | | 1 x 3 | 0 / 3 | PASS |
| ESD (CDM) JESD22-C101 | CDM**** | C3 (> 1000 V) | | 1 x 3 | 0 / 3 | PASS |

Environmental Stress Test Results:

| Test Description | Abbr. | Condition | Duration | Lots/SS | Fail/Qty | Result |
|---|---------------|---|-----------|---------|----------|--------|
| Pre-conditioning (SMD device only) J-STD020 / JESD22 A113 | PC | MSL and 3x reflow 260°C | | 3x 231 | 0 / 693 | PASS |
| Resistance to Solder Heat (TH device only) JESD B-106 | SHR | Solder dip Ts=260°C 3x 10 sec | | 3x 22 | 0 / 66 | PASS |
| Temperature Cycling JESD22 A104 | TC* | -55°C to +150°C | 1000 cyc. | 3 x 77 | 0 / 231 | PASS |
| Autoclave*** JESD22 A102 or Unbiased Highly Accelerated Stress Test *** JESD22 A118 | AC* UHAST* | Ta=121°C RH=100% Ta = 130°C RH = 85% | 96 h | 3 x 77 | 0 / 231 | PASS |

Mechanical Stress Test Results:

| Test Description | Abbr. | Condition | Duration | Lots/SS | Fail/Qty | Result |
|-----------------------------------|-------|-----------|----------|---------|----------|--------|
| Physical Dimensions JESD B-100 | PD | | | 3 x 10 | 0 / 30 | PASS |
| Solderability J-STD-002 | SD | | | 3 x 5 | 0 / 15 | PASS |

Notes:

- * For SMD devices reliability stress tests are performed after preconditioning test (PC) according to JESD22
- ** Specifically used stress temperature is according to product capability documented in the product datasheet
- *** Selection of used stress test depending on specific availability of respective reliability stress equipment
- **** ESD classification calculated based on an empirical model extracted per technology/package

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Document reference

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